SWITCHMODE **Power Rectifiers**

These state-of-the-art devices have the following features:

Features

- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After **Board Mounting**
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Wettable Flacks Option Available
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb–Free and Halide–Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

MAXIMUM RATINGS

Rating Symbol Value				
Katilig	Symbol	value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V	
Average Rectified Forward Current (Rated V _R , T _C = 143°C)	I _{F(AV)}	8.0	A	
Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 143°C)	I _{FRM}	16	A	
Non–Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	A	
Storage Temperature Range	T _{stg}	-65 to +150	°C	
Operating Junction Temperature	TJ	-40 to +150	°C	
Unclamped Inductive Switching Energy (10 mH Inductor, Non–repetitive)	E _{AS}	100	mJ	
ESD Rating (Human Body Model)		3B		
ESD Rating (Machine Model)		M4		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: The heat generated must be less than the thermal conductivity from Junction-to-Ambient: dPD/dTJ < 1/RJA.



ON Semiconductor®

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SCHOTTKY BARRIER RECTIFIERS 8 AMPERES **30 VOLTS**





= Assembly Location

= Year

Υ

W

77

- = Work Week
- = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping†
MBR830MFST1G	SO–8 FL (Pb–Free)	1500 / Tape & Reel
MBR830MFST3G	SO–8 FL (Pb–Free)	5000 / Tape & Reel
NRVB830MFST1G	SO–8 FL (Pb–Free)	1500 / Tape & Reel
NRVB830MFST3G	SO–8 FL (Pb–Free)	5000 / Tape & Reel

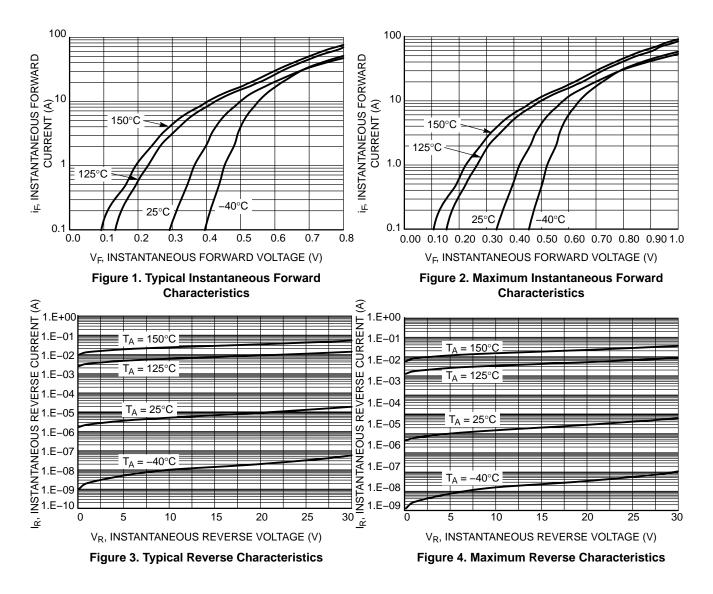
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Тур	Мах	Unit
Thermal Resistance, Junction-to-Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board)	R _{θJC}	-	2.0	°C/W
ELECTRICAL CHARACTERISTICS				

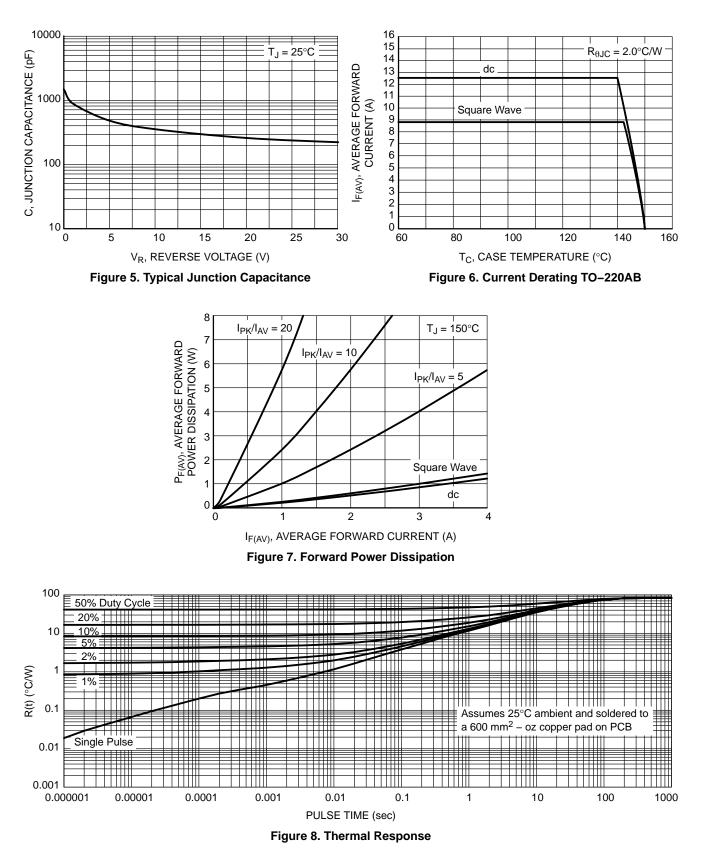
Instantaneous Forward Voltage (Note 1) ($i_F = 8 \text{ Amps}, T_J = 125^{\circ}C$) ($i_F = 8 \text{ Amps}, T_J = 25^{\circ}C$)	۷F	0.44 0.50	0.57 0.70	V
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$)	i _R	15 0.020	50 0.200	mA

1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

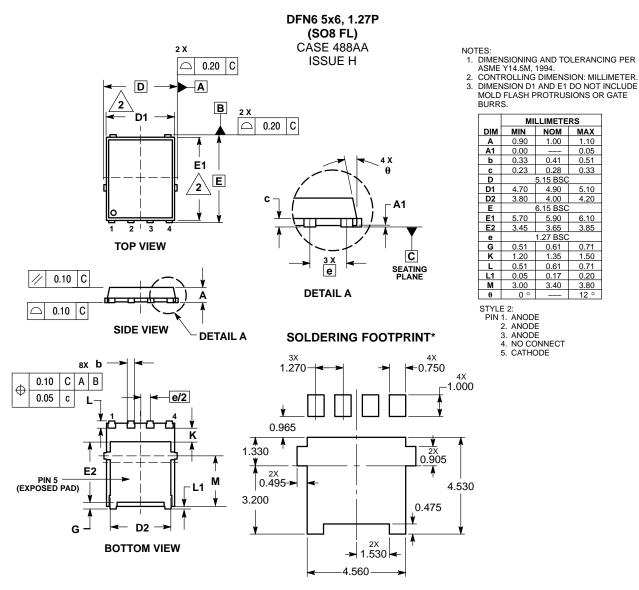


TYPICAL CHARACTERISTICS

TYPICAL CHARACTERISTICS



PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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